MICROCHIP

MX554ENU840M000

Ultra-Low Jitter 840MHz HCSL XO

ClockWorks® FUSION

General Description

The MX554ENU840M000 is an ultra-low phase jitter XO with HCSL output optimized for high line rate applications.

Features

- 840MHz HCSL
- Typical phase noise:
 - 100fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

Absolute Maximum Ratings¹

Supply Voltage (VIN)	+4.6V
Lead Temperature (soldering, 10s)	260°C
Case Temperature	115°C
Storage Temperature (T _S) ESD Machine Model	65°C to +125°C
ESD Machine Model	200V
ESD Rating (HBM)	2kV

Operating Ratings²

Supply Voltage (VIN)	+2.375V to $+3.63V$
Ambient Temperature (TA)	40°C to $+85$ °C
Junction Thermal Resistance	
LGA (T _{IA}) Still Air	58°C/W
` JA´	

Electrical Characteristics

VDD = $2.5V \pm 5\%$ or $3.3V \pm 10\%$, -40° C to $+85^{\circ}$ C, outputs terminated with 50 Ohms to VSS.³

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current				95	mA
F0	Center Frequency			840		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		220 100		fsRMS
Tstart	Start-Up Time				10	ms
TR/TF	Rise/Fall time	20%-80%	150	300	450	ps
	Duty Cycle		48	50	52	%
VOH	Output High Voltage	HCSL output levels	660	700	850	mV
VOL	Output Low Voltage	HCSL output levels	-150	0	27	mV
VOVS	Max Output Including Overshoot				VOH + 0.3	V
VUDS	Min Output Including Undershoot		VOL - 0.3			V
VRB	Ringback Voltage		0.2			V
VOX	Absolute Crossing Point		250	350	550	mV
Vswing	Peak to Peak Output Voltage Swing		640	700	950	mV

Notes:

- $1. \ Exceeding \ the \ absolute \ maximum \ ratings \ may \ damage \ the \ device.$
- 2. The device is not guaranteed to function outside its operating ratings.
- 3. Guaranteed after thermal equilibrium.
- 4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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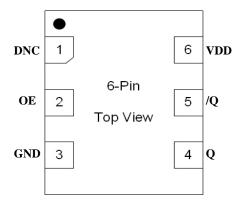
February 26, 2019 MX554EN2-7534 Revision 1.0 tcghelp@microchip.com

Ordering Information

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX554ENU840M000	MX554E	NU8400	Tube	6-Pin 5mm x 3.2mm LGA
MX554ENU840M000-TR	MX554E	NU8400	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

Pin Configuration



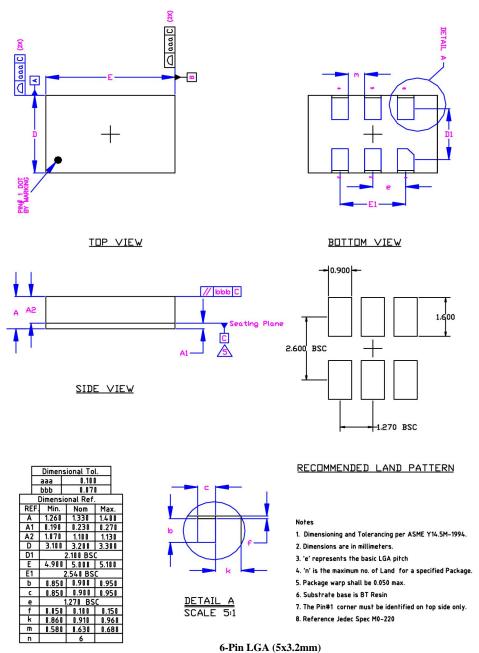
Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	DNC			Make no connection, leave floating.
2	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50k Ohms Pull-Up (Internal)
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	HCSL	Clock Output Frequency = 840MHz
6	VDD	PWR		Power Supply

Environmental Specifications

Thermal Shock	MIL-STD-883, Method 1011, Condition A		
Moisture Resistance	MIL-STD-883, Method 1004		
Mechanical Shock	MIL-STD-883, Method 2002, Condition E		
Mechanical Vibration	MIL-STD-883, Method 2007, Condition C		
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)		
Hazardous Substance	Pb-Free / RoHS / Green Compliant		
Solderability	JESD22-B102-D Method 2 (Preconditioning E)		
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D		
Gross Leak	MIL-STD-883, Method 1014, Condition C		
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s		
Solvent Resistance	MIL-STD-202, Method 215		

Package Information and Recommended Land Pattern for 6-Pin LGA³



Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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